# DATA SHEET



Solid State Relay OCMOS FET

# PS7113-1A,-2A,PS7113L-1A,-2A

## 6, 8-PIN DIP, 350 mA CONTINUOUS LOAD CURRENT 1-ch, 2-ch Optical Coupled MOS FET

#### DESCRIPTION

The PS7113-1A, -2A and PS7113L-1A, -2A are solid state relays containing GaAs LEDs on the light emitting side (input side) and MOS FETs on the output side.

They are suitable for analog signal control because of their low offset and high linearity.

The PS7113L-1A, -2A have a surface mount type lead.

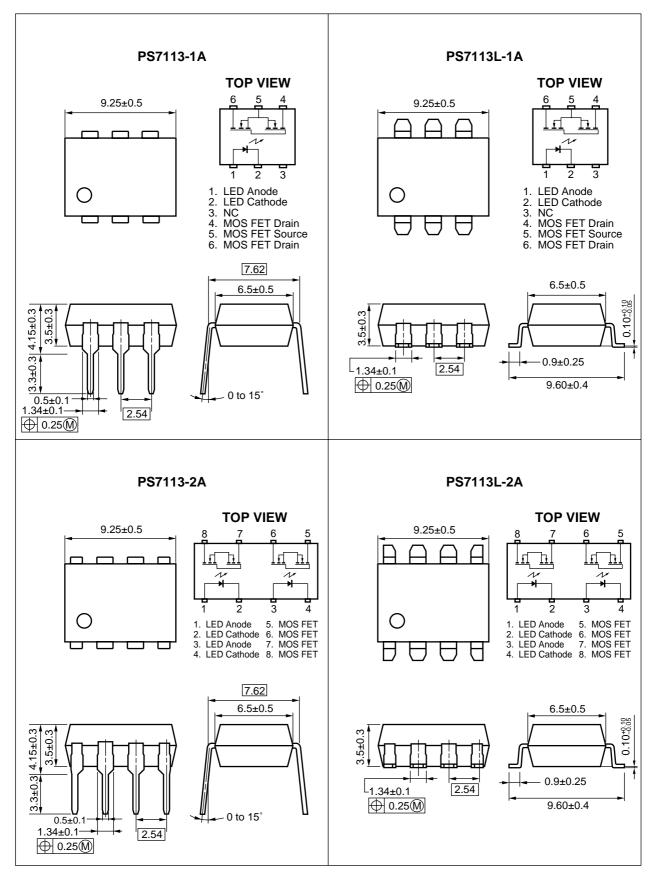
#### **\*** FEATURES

- 1 channel type (1 a output) or 2 channel type (1 a + 1 a output)
- Low LED operating current (IF = 2 mA)
- Designed for AC/DC switching line changer
- Small package (6, 8-pin DIP)
- Low offset voltage
- PS7113L-1A, -2A: Surface mount type
- UL approved: File No. E72422 (S)
- BSI approved: No. 8245/8246
- CSA approved: No. CA 101391

#### APPLICATIONS

- Exchange equipment
- Measurement equipment
- FA/OA equipment





#### **\*** ORDERING INFORMATION

Part Number	Package	Packing Style	Application Part Number <sup>*1</sup>
PS7113-1A	6-pin DIP	Magazine case 50 pcs	PS7113-1A
PS7113L-1A			PS7113L-1A
PS7113L-1A-E3		Embossed Tape 1 000 pcs/reel	
PS7113L-1A-E4			
PS7113-2A	8-pin DIP	Magazine case 50 pcs	PS7113-2A
PS7113L-2A			PS7113L-2A
PS7113L-2A-E3		Embossed Tape 1 000 pcs/reel	
PS7113L-2A-E4			

\*1 For the application of the Safety Standard, following part number should be used.

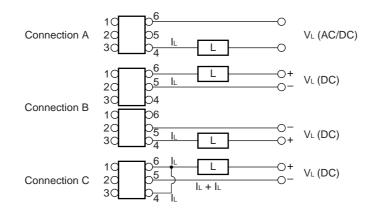
\*

Parameter				Rati		
			Symbol	PS7113-1A, PS7113L-1A	PS7113-2A, PS7113L-2A	Unit
Diode	Forward Current (DC)		lf	50		mA
	Reverse Voltage		Vr	5.0		V
	Power Dissipation		PD	50		mW/ch
	Peak Forward Current <sup>1</sup>		IFP	1		А
MOS FET	S FET      Break Down Voltage      VL      100        Continuous      Connection A      IL      350		VL	100		V
			50	mA		
	Load Current <sup>*2</sup>	Connection B		450	_	
		Connection C		700	-	
	Pulse Load Current <sup>*3</sup> (AC/DC Connection)		LP	600		mA
	Power Dissipation		PD	560	375	mW/ch
Isolation Voltage <sup>*</sup>			BV	1 500		Vr.m.s.
Total Power Dissipation			Ρτ	610	850	mW
Operating Ambient Temperature			TA	-40 to +80		°C
Storage Temperature			Tstg	-40 to +100		°C

#### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, unless otherwise specified)

\*1 PW = 100  $\mu$ s, Duty Cycle = 1 %

\*2 Conditions: IF  $\geq$  2 mA. The following types of load connections are available.



\*3 PW = 100 ms, 1 shot

\*4 AC voltage for 1 minute at  $T_A = 25$  °C, RH = 60 % between input and output

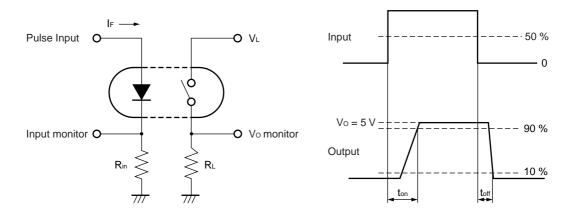
#### **RECOMMENDED OPERATING CONDITIONS (TA = 25 °C)**

Parameter	Symbol MIN.		TYP.	MAX.	Unit
LED Operating Current	lF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

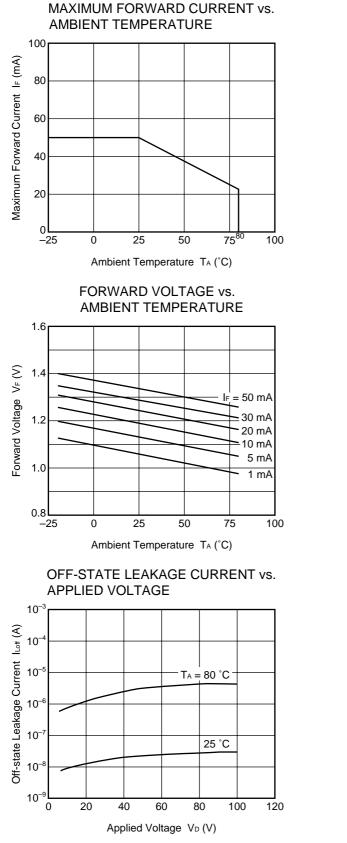
#### **\*** ELECTRICAL CHARACTERISTICS (TA = 25 °C)

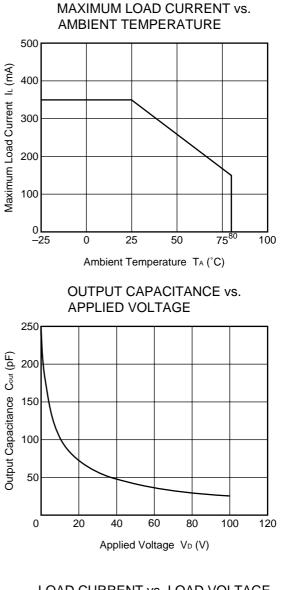
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	Ir	V <sub>R</sub> = 5 V			5.0	μA
MOS FET	Off-state Leakage Current	Loff	V <sub>D</sub> = 100 V		0.03	1.0	μA
	Output Capacitance	Cout	$V_D = 0 V$ , f = 1 MHz		250		pF/ch
Coupled	LED On-state Current	IFon	l∟ = 350 mA			2.0	mA
	On-state Resistance	Ron1	IF = 10 mA, IL = 10 mA		0.9	2.5	Ω
		Ron2	$I_{\text{F}}$ = 10 mA, $I_{\text{L}}$ = 350 mA, $t \leq$ 10 ms				
	Turn-on Time <sup>⁺1</sup>	ton	$I_{\text{F}}$ = 10 mA, Vo = 5 V, PW $\geq$ 10 ms		1.3	3.0	ms
	Turn-off Time <sup>™</sup>	toff			0.06	0.2	
	Isolation Resistance	Ri-o	VI-O = 1.0 kVDC	10 <sup>°</sup>			Ω
	Isolation Capacitance	CI-0	V = 0 V, f = 1 MHz		1.1		pF/ch

\*1 Test Circuit for Switching Time

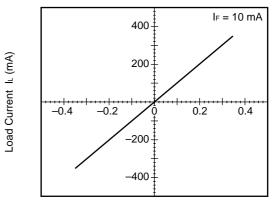


#### ★ TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise specified)



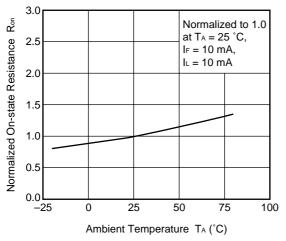


LOAD CURRENT vs. LOAD VOLTAGE

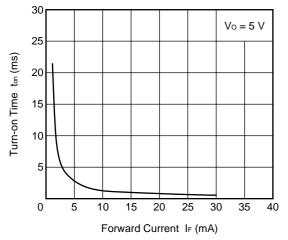


Load Voltage VL (V)

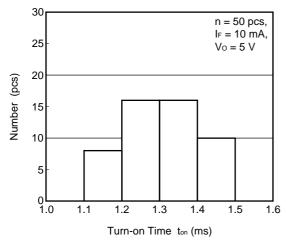
# NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



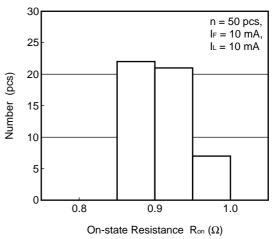
#### TURN-ON TIME vs. FORWARD CURRENT



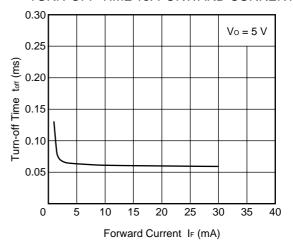
#### TURN-ON TIME DISTRIBUTION



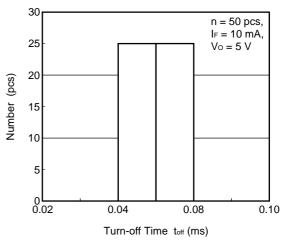
#### **ON-STATE RESISTANCE DISTRIBUTION**

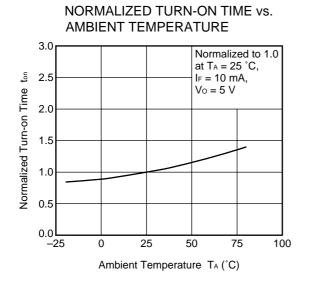


TURN-OFF TIME vs. FORWARD CURRENT

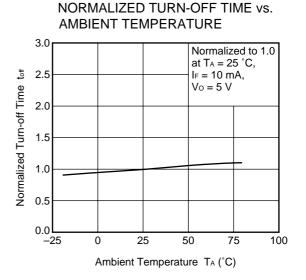


#### TURN-OFF TIME DISTRIBUTION

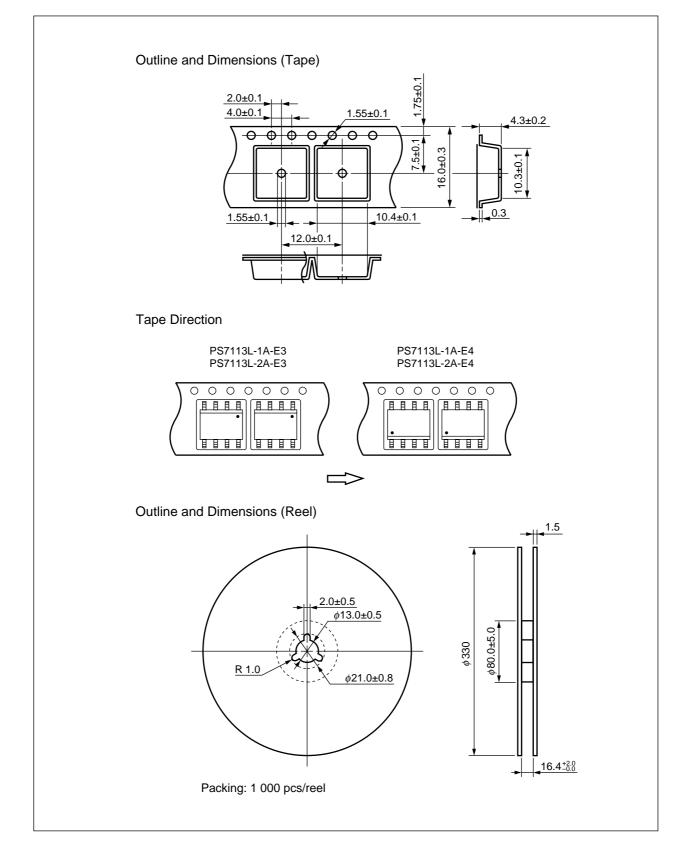




**Remark** The graphs indicate nominal characteristics.



**\*** TAPING SPECIFICATIONS (in millimeters)



#### **RECOMMENDED SOLDERING CONDITIONS**

#### (1) Infrared reflow soldering

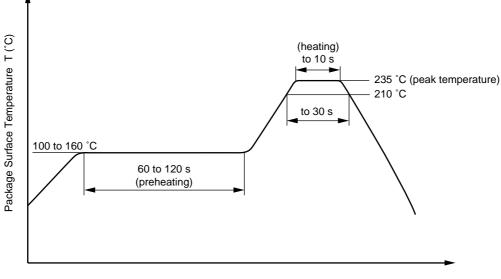
- Peak reflow temperature 235 °C (package surface temperature)
- Time of temperature higher than 210 °C
- Number of reflows
- Flux

+

Two Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

#### Recommended Temperature Profile of Infrared Reflow

30 seconds or less





#### (2) Dip soldering

#### • Temperature 260 °C or below (molten solder temperature)

- Time
  - e 10 seconds or less nber of times One
- Number of times
- Flux

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

#### (3) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

[MEMO]

### CAUTION

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. Please do not under any circumstances break the hermetic seal.

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